OIF Product Showcase at OFC Features Cutting-Edge Products
Utilizing OIF Supported Technology
OIF to Speak on 400G and SDN at OFC

Fremont, CA – Feb. 25, 2014 – Fifteen global OIF members are gathering at OFC in San Francisco, March 11-13, 2104 to showcase their cutting-edge products that utilize the latest OIF optical and electrical implementation agreements. The featured products include components, modules and other hardware supporting the OIF’s Physical and Link Layer (PLL) implementation agreements or ongoing projects.

The showcase will feature a wide range of products that incorporate higher speed, higher density and longer reach technology to enable next generation network performance and efficiency. Highlighted in the showcase will be OIF implementation agreements such as the Common Electrical Interfaces (CEI) for 28G very short reach (VSR), short reach (SR) and medium reach (MR) as well as the 25G long reach (LR). Also shown will be products that incorporate the OIF’s MultiLink Gearbox and components for next generation long haul and coherent optics.

“We are excited for the industry to reflect how many different OIF IA projects are being applied to real-world products that are either available today or are being readied for deployment,” said Brian Holden of Kandou Bus and the OIF’s Marketing Education & Awareness Committee co-chair. “It is encouraging to see the Forum’s work coming to fruition.”

The following companies are participating in the OIF Product Showcase in booth #2309 at OFC: Agilent Technologies, Amphenol, Applied Micro, Finisar, Inphi, Molex, MoSys, NEC, NeoPhotonics, Oclaro, Picometrix, Semtech, TE Connectivity, Xilinx and Yamaichi Electronics.

OFC Expo Theatre III Presentations

56 Gbps serial – Why, What, When - Wed Mar 12, 11am-12pm
This panel will discuss the implications, applications and roll-out of 56 Gb/s interfaces in a broad system-oriented context.

Moderator: Nathan Tracy, OIF Technical Committee chair, TE Connectivity

Panelists:
- Ed Frlan, OIF PLL Interop Working Group chair, Semtech
- Brian Holden, OIF MA&E co-chair - PLL, Kandou Bus
• Tom Palkert, OIF PLL WG vice chair - Electrical, Luxtera

**Carrier SDN Drivers and Evolution** - Wed Mar 12, 2pm-3pm
This panel will discuss the new networking approaches of SDN and NFV and how the OIF is helping to define the role of optical transport networks in these new architectures.

Moderator: Dave Brown, OIF vice president of marketing, Alcatel-Lucent
Panelists:
• Hans-Martin Foisel, Deutsche Telekom
• Julio de Oliveira, CPqD
• Konstantinos Kanonakis, NEC Laboratories America
• Lyndon Ong, ONF Optical Transport Working Group chair, OIF MA&E co-chair Networking, Ciena
• Jonathan Sadler, OIF TC vice chair, Tellabs
• Ljubisa Tancevski, Alcatel-Lucent

**About the OIF**
Launched in 1998, the OIF is the first industry group to unite representatives from data and optical networking disciplines, including many of the world’s leading carriers, component manufacturers and system vendors. The OIF promotes the development and deployment of interoperable networking solutions and services through the creation of Implementation Agreements (IAs) for optical, interconnect, network processing, component and networking systems technologies. The OIF actively supports and extends the work of standards bodies and industry forums with the goal of promoting worldwide compatibility of optical internetworking products. Information on the OIF can be found at [http://www.oiforum.com](http://www.oiforum.com).

For more information contact:
Deborah Porchivina
PAPR
415-272-0943
Deborah@papr.com